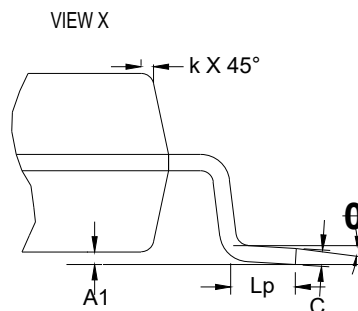
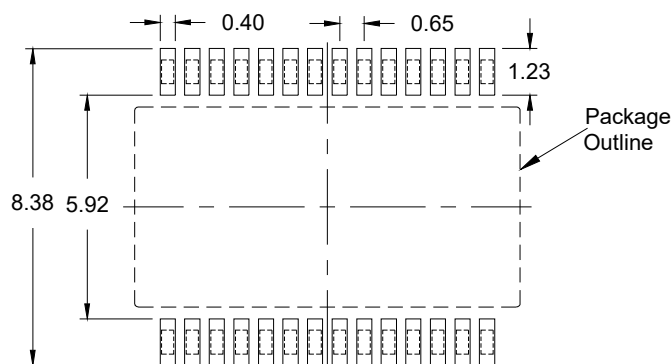
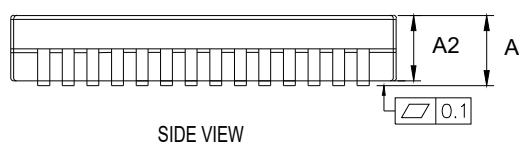
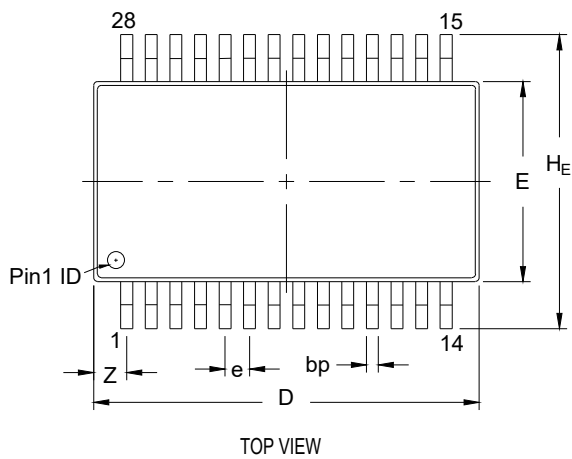


BASED ON JEDEC JEP95: MO-150



DIMENSIONS OF SUB-GROUP C1	
A min	1.73
A1 min	0.05
A1 max	0.21
A2 min	1.68
A2 max	1.78
c min	0.09
c max	0.20
D min*	10.07
D max*	10.33
E min*	5.20
E max*	5.38
k min	0.25
θ max	0°
θ max	10°

* WITHOUT MOLD FLASH

DIMENSIONS OF SUB-GROUP B1	
A max	1.99
bp min	0.25
bp max	0.38
e nom	0.65
HE min	7.40
HE max	8.20
Lpmin	0.63
Z max	1.22

- Dimensions
- Weight ≤ 0.4 g
- Body Material LOW STRESS EPOXY
- Lead Material FeNi-ALLOY or Cu-ALLOY
- Lead Finish SOLDER PLATING
- Lead Form Z-BENDS

NOTES:

- JEDEC compatible.
- All dimensions are in mm and angles are in degrees.